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Understanding [Embedded - Microprocessors](#)

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

Applications of [Embedded - Microprocessors](#)

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details

Product Status	Obsolete
Core Processor	MIPS32
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	350MHz
Co-Processors/DSP	-
RAM Controllers	DDR
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	10/100Mbps (1)
SATA	-
USB	-
Voltage - I/O	3.3V
Operating Temperature	0°C ~ 70°C (TA)
Security Features	-
Package / Case	256-LBGA
Supplier Device Package	256-CABGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/79rc32h435-350bcg

◆ Non-Volatile RAM

- Provides 512-bits of non-volatile storage
- Eliminates need for external boot configuration vector
- Stores initial PCI configuration register values when PCI configured to operate in satellite mode with suspended CPU execution
- Authorization unit ensures only authorized software will operate on the system

◆ Memory and Peripheral Device Controller

- Provides “glueless” interface to standard SRAM, Flash, ROM, dual-port memory, and peripheral devices
- Demultiplexed address and data buses: 8-bit data bus, 26-bit address bus, 4 chip selects, control for external data bus buffers

Automatic byte gathering and scattering

- Flexible protocol configuration parameters: programmable number of wait states (0 to 63), programmable postread/post-write delay (0 to 31), supports external wait state generation, supports Intel and Motorola style peripherals
- Write protect capability per chip select
- Programmable bus transaction timer generates warm reset when counter expires
- Supports up to 64 MB of memory per chip select

◆ DMA Controller

- 6 DMA channels: two channels for PCI (PCI to Memory and Memory to PCI), two channels for the Ethernet interface, and two channels for memory to memory DMA operations
- Provides flexible descriptor based operation
- Supports unaligned transfers (i.e., source or destination address may be on any byte boundary) with arbitrary byte length

◆ Universal Asynchronous Receiver Transmitter (UART)

- Compatible with the 16550 and 16450 UARTs
- 16-byte transmit and receive buffers
- Programmable baud rate generator derived from the system clock
- Fully programmable serial characteristics:
 - 5, 6, 7, or 8 bit characters
 - Even, odd or no parity bit generation and detection
 - 1, 1-1/2 or 2 stop bit generation
- Line break generation and detection
- False start bit detection
- Internal loopback mode

◆ I²C-Bus

- Supports standard 100 Kbps mode as well as 400 Kbps fast mode
- Supports 7-bit and 10-bit addressing
- Supports four modes: master transmitter, master receiver, slave transmitter, slave receiver

◆ Additional General Purpose Peripherals

- Interrupt controller
- System integrity functions
- General purpose I/O controller
- Serial peripheral interface (SPI)

◆ Counter/Timers

- Three general purpose 32-bit counter timers
- Timers may be cascaded
- Selectable counter/timer clock source

◆ JTAG Interface

- Compatible with IEEE Std. 1149.1 - 1990

CPU Execution Core

The 32-bit CPU core is 100% compatible with the MIPS32 instruction set architecture (ISA). Specifically, this device features the 4Kc CPU core developed by MIPS Technologies Inc. (www.mips.com). This core issues a single instruction per cycle, includes a five stage pipeline and is optimized for applications that require integer arithmetic.

The CPU core includes 8 KB instruction and 8 KB data caches. Both caches are 4-way set associative and can be locked on a per line basis, which allows the programmer control over this precious on-chip memory resource. The core also features a memory management unit (MMU). The CPU core also incorporates an enhanced joint test access group (EJTAG) interface that is used to interface to in-circuit emulator tools, providing access to internal registers and enabling the part to be controlled externally, simplifying the system debug process.

The use of this core allows IDT's customers to leverage the broad range of software and development tools available for the MIPS architecture, including operating systems, compilers, and in-circuit emulators.

PCI Interface

The PCI interface on the RC32435 is compatible with version 2.2 of the PCI specification. An on-chip arbiter supports up to six external bus masters, supporting both fixed priority and rotating priority arbitration schemes. The part can support both satellite and host PCI configurations, enabling the RC32435 to act as a slave controller for a PCI add-in card application or as the primary PCI controller in the system. The PCI interface can be operated synchronously or asynchronously to the other I/O interfaces on the RC32435 device.

Ethernet Interface

The RC32435 has one Ethernet Channel supporting 10Mbps and 100Mbps speeds to provide a standard media independent interface (MII or RMII), allowing a wide range of external devices to be connected efficiently.

Double Data Rate Memory Controller

The RC32435 incorporates a high performance double data rate (DDR) memory controller which supports x16 memory configurations up to 256MB. This module provides all of the signals required to interface to discrete memory devices, including a chip select, differential clocking outputs and data strobes.

Memory and I/O Controller

The RC32435 uses a dedicated local memory/I/O controller including a de-multiplexed 8-bit data and 26-bit address bus. It includes all of the signals required to interface directly to a maximum of four Intel or Motorola-style external peripherals.

DMA Controller

The DMA controller consists of 6 independent DMA channels, all of which operate in exactly the same manner. The DMA controller off-loads the CPU core from moving data among the on-chip interfaces, external peripherals, and memory. The controller supports scatter/gather DMA with no alignment restrictions, making it appropriate for communications and graphics systems.

UART Interface

The RC32435 contains a serial channel (UART) that is compatible with the industry standard 16550 UART.

I²C Interface

The standard I2C interface allows the RC32435 to connect to a number of standard external peripherals for a more complete system solution. The RC32435 supports both master and slave operations.

General Purpose I/O Controller

The RC32435 has 14 general purpose input/output pins. Each pin may be used as an active high or active low level interrupt or non-maskable interrupt input, and each signal may be used as a bit input or output port.

System Integrity Functions

The RC32435 contains a programmable watchdog timer that generates a non-maskable interrupt (NMI) when the counter expires and also contains an address space monitor that reports errors in response to accesses to undecoded address regions.

Thermal Considerations

The RC32435 is guaranteed in an ambient temperature range of 0° to +70° C for commercial temperature devices and - 40° to +85° for industrial temperature devices.

Revision History

January 19, 2006: Initial publication.

Signal	Type	Name/Description
PCILOCKN	I/O	PCI Lock. This signal is asserted by an external bus master to indicate that an exclusive operation is occurring.
PCIPAR	I/O	PCI Parity. Even parity of the PCIAD[31:0] bus. Driven by the bus master during address and write Data phases. Driven by the bus target during the read data phase.
PCIPERRN	I/O	PCI Parity Error. If a parity error is detected, this signal is asserted by the receiving bus agent 2 clocks after the data is received.
PCIREQN[3:0]	I/O	<p>PCI Bus Request.</p> <p>In PCI host mode with internal arbiter: These signals are inputs whose assertion indicates to the internal RC32435 arbiter that an agent desires ownership of the PCI bus.</p> <p>In PCI host mode with external arbiter: PCIREQN[0]: asserted by the RC32435 to request ownership of the PCI bus. PCIREQN[3:1]: unused and driven high.</p> <p>In PCI satellite mode: PCIREQN[0]: this signal is asserted by the RC32435 to request use of the PCI bus. PCIREQN[1]: function changes to PCIIDSEL and is used as a chip select during configuration read and write transactions. PCIREQN[3:2]: unused and driven high.</p>
PCIRSTN	I/O	PCI Reset. In host mode, this signal is asserted by the RC32435 to generate a PCI reset. In satellite mode, assertion of this signal initiates a warm reset.
PCISERRN	I/O	PCI System Error. This signal is driven by an agent to indicate an address parity error, data parity error during a special cycle command, or any other system error. Requires an external pull-up.
PCISTOPN	I/O	PCI Stop. Driven by the bus target to terminate the current bus transaction. For example, to indicate a retry.
PCITRDYN	I/O	PCI Target Ready. Driven by the bus target to indicate that the current data can complete.
General Purpose Input/Output		
GPIO[0]	I/O	<p>General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: U0SOUT Alternate function: UART channel 0 serial output.</p>
GPIO[1]	I/O	<p>General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: U0SINP Alternate function: UART channel 0 serial input.</p>
GPIO[2]	I/O	<p>General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: U0RTSN Alternate function: UART channel 0 request to send.</p>
GPIO[3]	I/O	<p>General Purpose I/O. This pin can be configured as a general purpose I/O pin. Alternate function pin name: U0CTSN Alternate function: UART channel 0 clear to send.</p>

Table 1 Pin Description (Part 3 of 6)

Pin Characteristics

Note: Some input pads of the RC32435 do not contain internal pull-ups or pull-downs. Unused inputs should be tied off to appropriate levels. This is especially critical for unused control signal inputs (such as WAITACKN) which, if left floating, could adversely affect the RC32435's operation. Also, any input pin left floating can cause a slight increase in power consumption.

Function	Pin Name	Type	Buffer	I/O Type	Internal Resistor	Notes ¹
Memory and Peripheral Bus	BDIRN	O	LVTTL	High Drive		
	BOEN	O	LVTTL	High Drive		
	WEN	O	LVTTL	High Drive		
	CSN[3:0]	O	LVTTL	High Drive		
	MADDR[21:0]	I/O	LVTTL	High Drive		
	MDATA[7:0]	I/O	LVTTL	High Drive		
	OEN	O	LVTTL	High Drive		
	RWN	O	LVTTL	High Drive		
	WAITACKN	I	LVTTL	STI	pull-up	
DDR Bus	DDRADDR[13:0]	O	SSTL_2			
	DDRBA[1:0]	O	SSTL_2			
	DDRCASN	O	SSTL_2			
	DDRCKE	O	SSTL_2 / LVC-MOS			
	DDRCKN	O	SSTL_2			
	DDRCKP	O	SSTL_2			
	DDRCASN	O	SSTL_2			
	DDRDATA[15:0]	I/O	SSTL_2			
	DDRDM[1:0]	O	SSTL_2			
	DDRDOQS[1:0]	I/O	SSTL_2			
	DDRRASN	O	SSTL_2			
	DDRVREF	I	Analog			
	DDRWEN	O	SSTL_2			
PCI Bus Interface	PCIAD[31:0]	I/O	PCI			
	PCICBEN[3:0]	I/O	PCI			
	PCICLK	I	PCI			
	PCIDEVSELN	I/O	PCI			pull-up on board
	PCIFRAMEN	I/O	PCI			pull-up on board
	PCIGNTN[3:0]	I/O	PCI			pull-up on board
	PCIIRDYN	I/O	PCI			pull-up on board
	PCILOCKN	I/O	PCI			
	PCIPAR	I/O	PCI			
	PCIPERRN	I/O	PCI			
	PCIREQN[3:0]	I/O	PCI			pull-up on board
	PCIRSTN	I/O	PCI			pull-down on board
	PCISERRN	I/O	PCI	Open Collector		pull-up on board
	PCISTOPN	I/O	PCI			pull-up on board
	PCITRDYN	I/O	PCI			pull-up on board
General Purpose I/O	GPIO[8:0]	I/O	LVTTL	High Drive	pull-up	
	GPIO[13:9]	I/O	PCI			pull-up on board

Table 2 Pin Characteristics (Part 1 of 2)

Signal	Name/Description
MADDR[11]	Disable Watchdog Timer. When this bit is set, the watchdog timer is disabled following a cold reset. 0x0 - Watchdog timer enabled 0x1 - Watchdog timer disabled
MADDR[13:12]	Reserved. These pins must be driven low during boot configuration.
MADDR[15:14]	Reserved. Must be set to zero.

Table 3 Boot Configuration Encoding (Part 2 of 2)

Logic Diagram — RC32435

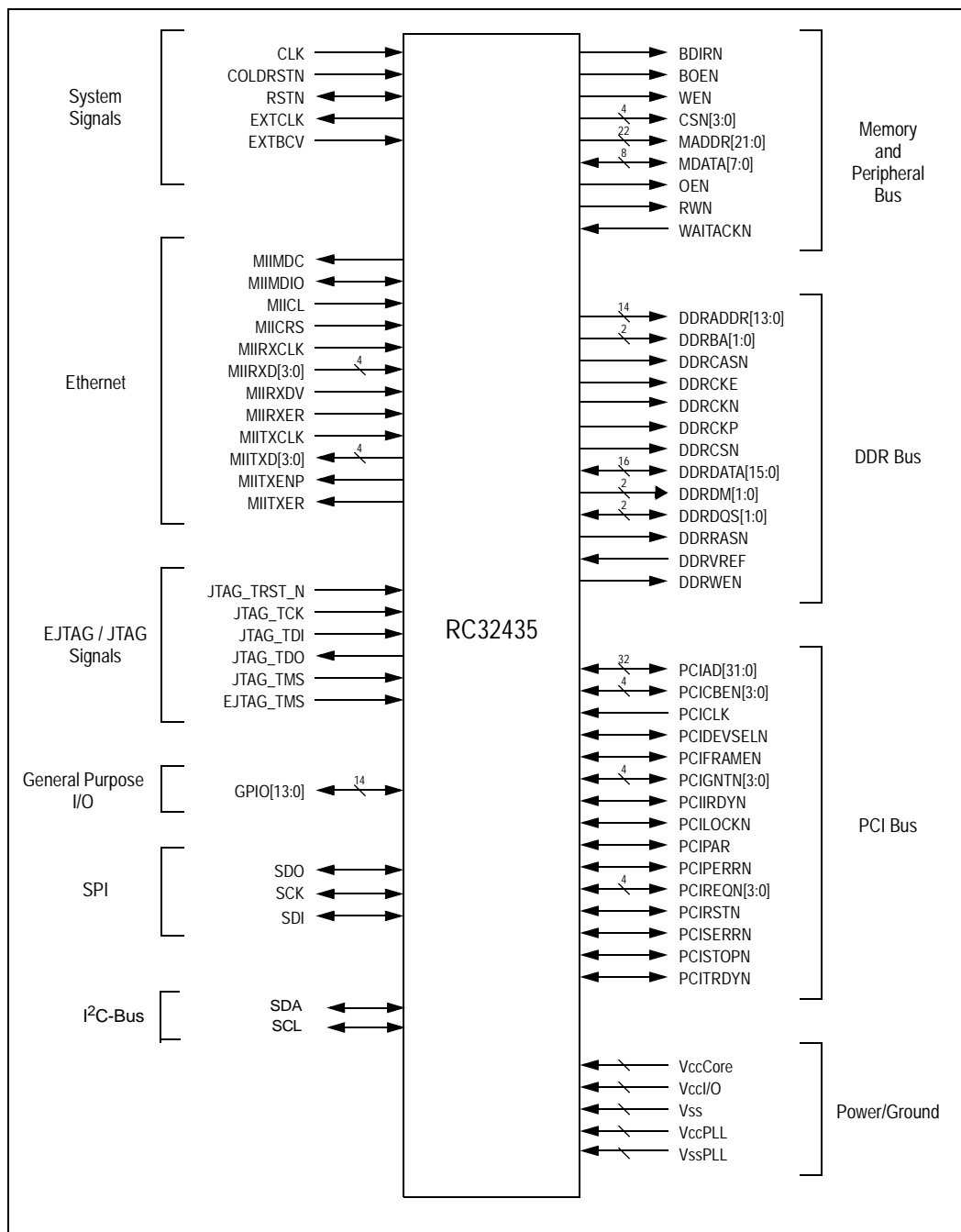


Figure 1 Logic Diagram

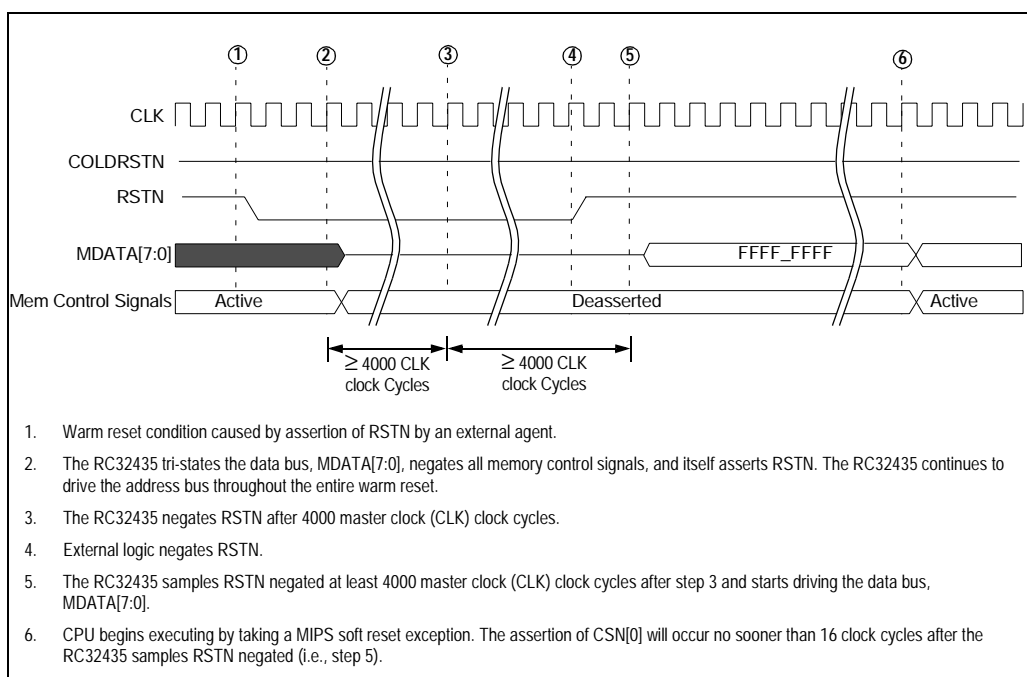


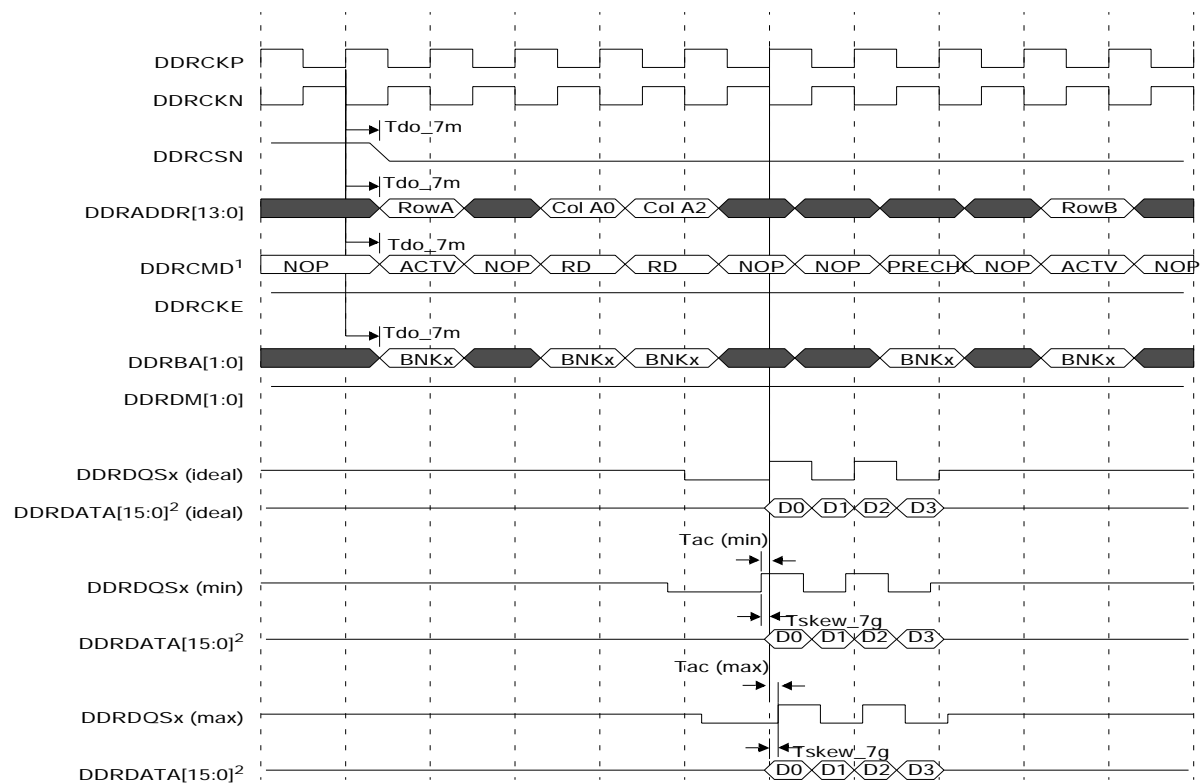
Figure 5 Externally Initiated Warm Reset AC Timing Waveform

Signal	Symbol	Reference Edge	266MHz		300MHz		350MHz		400MHz		Unit	Timing Diagram Reference
			Min	Max	Min	Max	Min	Max	Min	Max		
Memory Bus - DDR Access												
DDRDATA[15:0]	Tskew_7g	DDRQSDx	0	0.9	0	0.8 ¹	0	0.7	0.0	0.6	ns	See Figures 6 and 7.
	Tdo_7k ²		1.2	1.9	1.0	1.7	0.7	1.5	0.5	1.4	ns	
DDRDM[1:0]	Tdo_7l	DDRQSDx	1.2	1.9	1.0	1.7	0.7	1.5	0.5	1.4	ns	
DDRQDS[1:0]	Tdo_7i	DDRCKP	-0.75	0.75	-0.75	0.75	-0.7	0.7	-0.7	0.7	ns	
DDRADDR[13:0], DDRBA[1:0], DDRCASN, DDRCKE, DDRCASN, DDRRASN, DDRWEN	Tdo_7m	DDRCKP	1.0	4.0	1.0	4.3	1.0	4.0	1.0	4.0	ns	

Table 7 DDR SDRAM Timing Characteristics

¹ Meets DDR timing requirements for 150MHz clock rate DDR SDRAMs with 300 ps remaining margin to compensate for PCB propagation mismatches, which is adequate to guarantee functional timing, provided the RC32435 DDR layout guidelines are adhered to.

² Setup times are calculated as applicable clock period - Tdo max. For example, if the DDR is running at 266MHz, it uses a 133MHz input clock. The period for a 133MHz clock is 7.5ns. If the Tdo max value is 4.6ns, the T_{IS} parameter is 7.5ns minus 4.6ns = 2.9ns. The DDR spec for this parameter is 1ns, so there is 1.9ns of slack left over for board propagation. Calculations for T_{DS} are similar, but since this parameter is taken relative to the DDRDQS signals, which are referenced on both edges, the effective period with a 133MHz input clock is only 3.75ns. So, if the max Tdo is 1.9ns, we have 3.75ns minus 1.9ns = 1.85ns for T_{DS}. The DDR data sheet specs a value of 0.5ns for 266MHz, so this leaves 1.35ns slack for board propagation delays.



¹ DDRCMD contains DRRASN, DDRCASN and DDRWEN.

² DDRDATA is either 32-bits or 16-bits wide depending on the DBW control bit in DDRC Register (see Chapter 7, DDR Controller, in the RC32435 User Reference Manual).

Figure 6 DDR SDRAM AC Timing Waveform - SDRAM Read Access

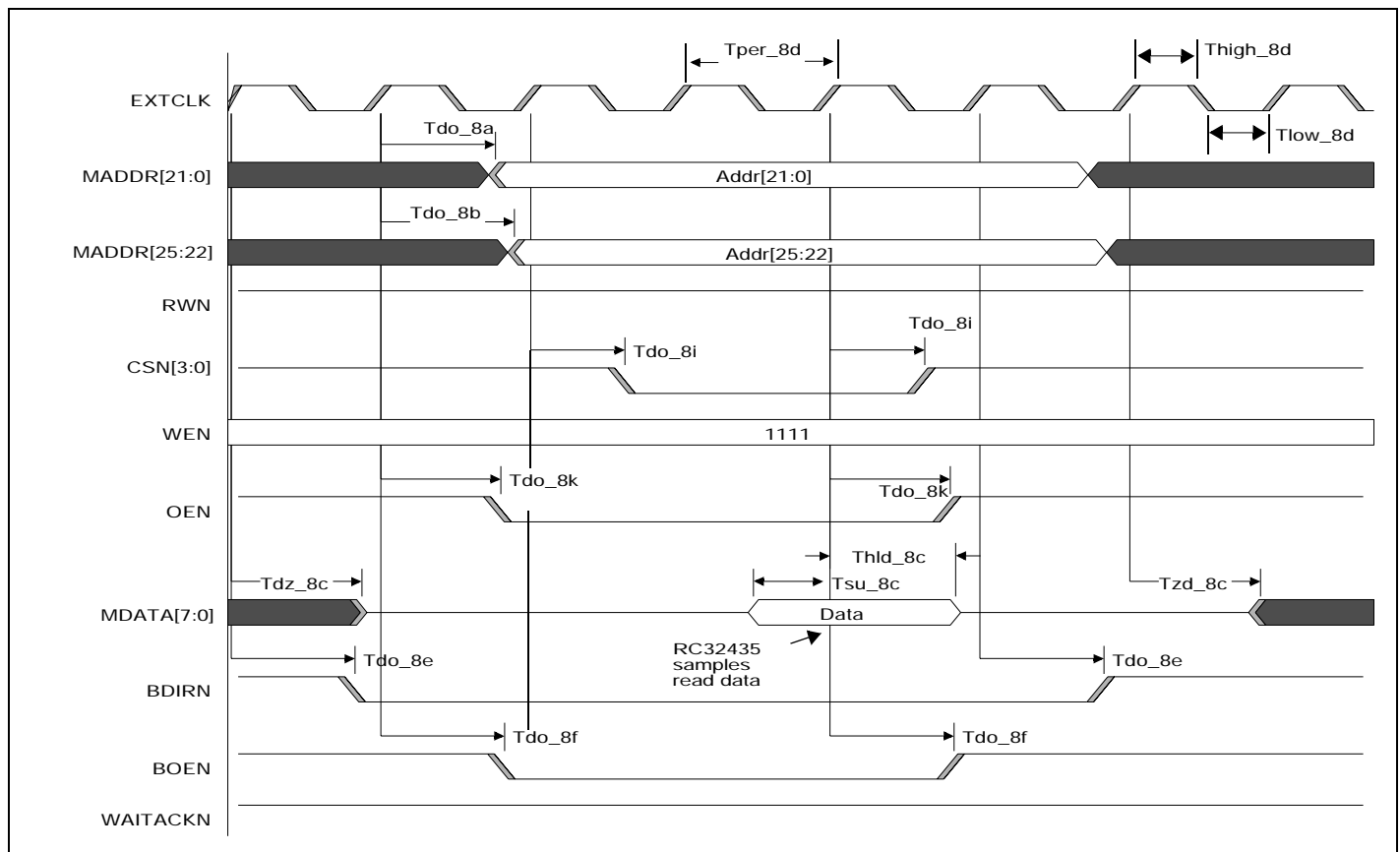


Figure 8 Memory and Peripheral Bus AC Timing Waveform — Read Access

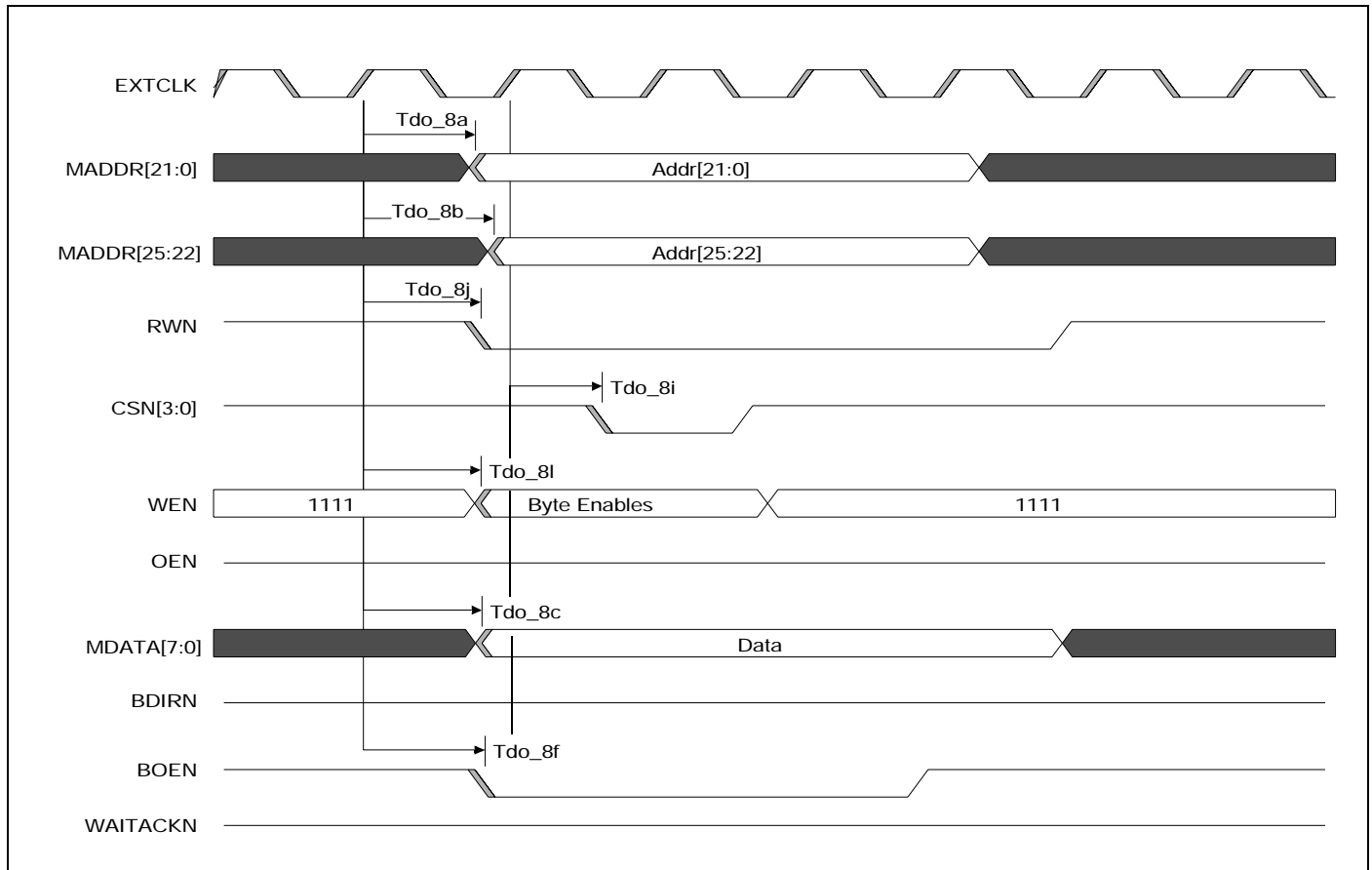


Figure 9 Memory and Peripheral Bus AC Timing Waveform — Write Access

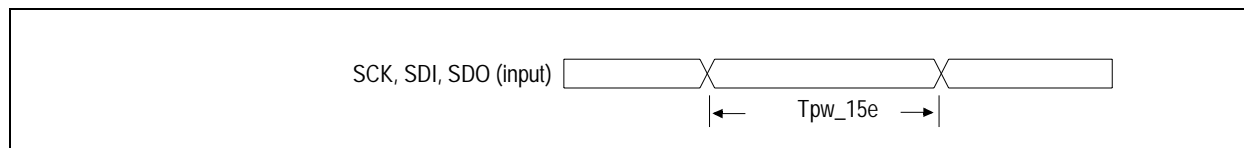


Figure 18 SPI AC Timing Waveform — Bit I/O Mode

Signal	Symbol	Reference Edge	266MHz		300MHz		350MHz		400MHz		Unit	Condi- tions	Timing Diagram Reference
			Min	Max	Min	Max	Min	Max	Min	Max			
EJTAG and JTAG													
JTAG_TCK	Tper_16a	none	25.0	50.0	25.0	50.0	25.0	50.0	25.0	50.0	ns		See Figure 19.
	Thigh_16a, Tlow_16a		10.0	25.0	10.0	25.0	10.0	25.0	10.0	25.0	ns		
JTAG_TMS ¹ , JTAG_TDI	Tsu_16b	JTAG_TCK rising	2.4	—	2.4	—	2.4	—	2.4	—	ns		
	Thld_16b		1.0	—	1.0	—	1.0	—	1.0	—	ns		
JTAG_TDO	Tdo_16c	JTAG_TCK fall- ing	—	11.3	—	11.3	—	11.3	—	11.3	ns		
	Tdz_16c ²		—	11.3	—	11.3	—	11.3	—	11.3	ns		
JTAG_TRST_N	Tpw_16d ²	none	25.0	—	25.0	—	25.0	—	25.0	—	ns		
EJTAG_TMS ¹	Tsu_16e	JTAG_TCK rising	2.0	—	2.0	—	2.0	—	2.0	—	ns		
	Thld_6e		1.0	—	1.0	—	1.0	—	1.0	—	ns		

Table 14 JTAG AC Timing Characteristics

¹ The JTAG specification, IEEE 1149.1, recommends that both JTAG_TMS and EJTAG_TMS should be held at 1 while the signal applied at JTAG_TRST_N changes from 0 to 1. Otherwise, a race may occur if JTAG_TRST_N is deasserted (going from low to high) on a rising edge of JTAG_TCK when either JTAG_TMS or EJTAG_TMS is low, because the TAP controller might go to either the Run-Test/Idle state or stay in the Test-Logic-Reset state.

² The values for this symbol were determined by calculation, not by testing.

Power-on Sequence

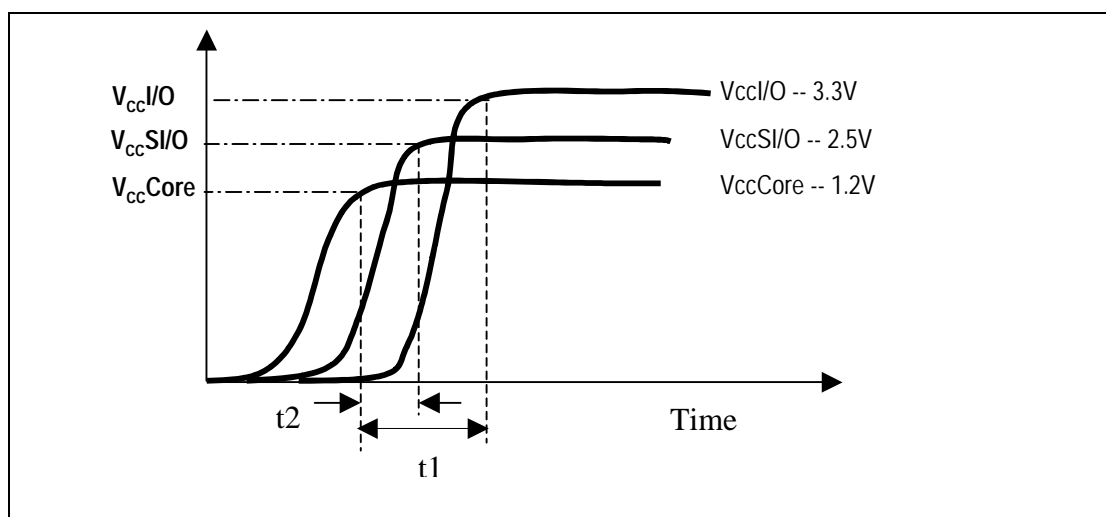
Three power-on sequences are given below. Sequence #1 is recommended because it will prevent I/O conflicts and will also allow the input signals to propagate when the I/O powers are brought up.

Note: The ESD diodes may be damaged if one of the voltages is applied and one of the other voltages is at a ground level.

A. Recommended Sequence

$t_2 > 0$ whenever possible ($V_{CC}Core$)

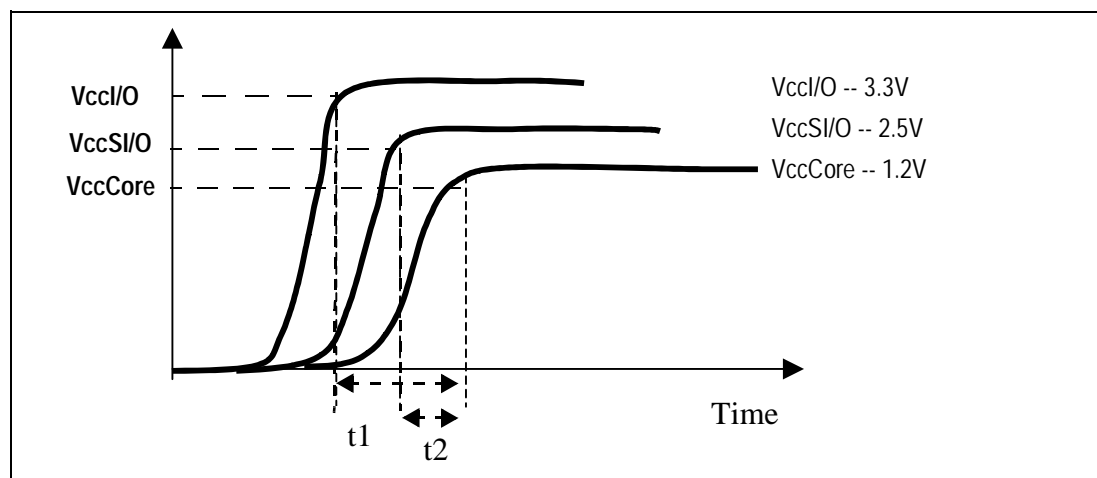
$t_1 - t_2$ can be 0 ($V_{CC}SI/O$ followed by $V_{CC}I/O$)



B. Reverse Voltage Sequence

If sequence A is not feasible, then Sequence B can be used:

$t_1 < 50ms$ and $t_2 < 50ms$ to prevent damage.



C. Simultaneous Power-up

$V_{CC}I/O$, $V_{CC}SI/O$, and $V_{CC}Core$ can be powered up simultaneously.

Pin	Function	Alt	Pin	Function	Alt	Pin	Function	Alt	Pin	Function	Alt
C2	BDIRN		G2	MIITXER		L2	SCL		R2	PCICBEN[3]	
C3	COLDRSTN		G3	MIIRXER		L3	GPIO[8]	1	R3	PCIAD[23]	
C4	WEN		G4	MIITXCLK		L4	SDI		R4	PCIAD[21]	
C5	MDATA[3]		G5	V _{cc} I/O		L5	V _{cc} I/O		R5	PCIAD[17]	
C6	MDATA[5]		G6	V _{ss}		L6	V _{ss}		R6	PCIRSTN	
C7	GPIO[6]	1	G7	V _{ss}		L7	V _{ss}		R7	PCICBEN[2]	
C8	MADDR[21]		G8	V _{ss}		L8	V _{cc} CORE		R8	PCITRDYN	
C9	MADDR[18]		G9	V _{ss}		L9	V _{ss}		R9	PCICBEN[1]	
C10	MADDR[14]		G10	V _{ss}		L10	V _{ss}		R10	PCIAD[12]	
C11	JTAG_TMS		G11	V _{ss}		L11	V _{ss}		R11	PCIAD[8]	
C12	V _{cc} APLL		G12	V _{cc} DDR		L12	V _{cc} DDR		R12	PCIAD[5]	
C13	CLK		G13	DDRDM[1]		L13	DDRADDR[9]		R13	PCIAD[3]	
C14	MADDR[4]		G14	DDRQOS[1]		L14	DDRWEN		R14	PCIAD[0]	
C15	MADDR[0]		G15	DDRDATA[10]		L15	DDRCASN		R15	PCIGNTN[2]	
C16	DDRDATA[0]		G16	DDRDATA[11]		L16	DDRADDR[8]		R16	DDRADDR[1]	
D1	MIIRXD[0]		H1	MIIMDIO		M1	GPIO[12]	1	T1	PCIAD[24]	
D2	MIICL		H2	MIIMDC		M2	PCIAD[31]		T2	GPIO[13]	1
D3	MIICRS		H3	GPIO[0]	1	M3	GPIO[11]	1	T3	PCIAD[22]	
D4	MIIRXD[1]		H4	GPIO[1]	1	M4	GPIO[9]	1	T4	PCIAD[19]	
D5	MDATA[7]		H5	V _{cc} CORE		M5	V _{cc} I/O		T5	PCIAD[16]	
D6	MDATA[2]		H6	V _{cc} CORE		M6	V _{cc} I/O		T6	PCICLK	
D7	MDATA[0]		H7	V _{ss}		M7	V _{cc} I/O		T7	PCIGNTN[0]	
D8	MADDR[20]		H8	V _{ss}		M8	V _{cc} CORE		T8	PCIDEVSELN	
D9	MADDR[19]		H9	V _{ss}		M9	V _{cc} CORE		T9	PCIPAR	
D10	MADDR[15]		H10	V _{ss}		M10	V _{cc} I/O		T10	PCIAD[13]	
D11	EXTBCV		H11	V _{ss}		M11	V _{cc} DDR		T11	PCIAD[9]	
D12	JTAG_TRSTN		H12	V _{cc} CORE		M12	V _{cc} DDR		T12	PCIAD[6]	
D13	WAITACKN		H13	DDRDATA[15]		M13	DDRRASN		T13	PCIAD[2]	
D14	DDRDATA[2]		H14	DDRDATA[14]		M14	DDRBA[1]		T14	PCIAD[1]	
D15	DDRDATA[3]		H15	DDRDATA[12]		M15	DDRADDR[6]		T15	PCIGNTN[1]	
D16	DDRDATA[1]		H16	DDRDATA[13]		M16	DDRADDR[7]		T16	PCIGNTN[3]	

Table 20 RC32435 Pinout (Part 2 of 2)

RC32435 Ground Pins

V _{SS}	V _{SS}	V _{SS} PLL
F6	J6	A11, B12
F7	J7	
F8	J8	
F10	J9	
F11	J10	
G6	K7	
G7	K8	
G8	K9	
G9	K10	
G10	K11	
G11	L6	
H7	L7	
H8	L9	
H9	L10	
H10	L11	
H11		

Table 23 RC32435 Ground Pins

RC32435 Signals Listed Alphabetically

The following table lists the RC32435 pins in alphabetical order.

Signal Name	I/O Type	Location	Signal Category
BDIRN	O	C2	Memory and Peripheral Bus
BOEN	O	B1	
CLK	I	C13	System
COLDRSTN	I	C3	
CSN[0]	O	A4	Memory and Peripheral Bus
CSN[1]	O	B4	
CSN[2]	O	A3	
CSN[3]	O	B3	

Table 24 RC32435 Alphabetical Signal List (Part 1 of 7)

Signal Name	I/O Type	Location	Signal Category
DDRADDR[0]	O	P14	DDR Bus
DDRADDR[1]	O	R16	
DDRADDR[2]	O	P15	
DDRADDR[3]	O	N15	
DDRADDR[4]	O	N14	
DDRADDR[5]	O	N13	
DDRADDR[6]	O	M15	
DDRADDR[7]	O	M16	
DDRADDR[8]	O	L16	
DDRADDR[9]	O	L13	
DDRADDR[10]	O	K15	
DDRADDR[11]	O	K14	
DDRADDR[12]	O	K16	
DDRADDR[13]	O	E15	
DDRBA[0]	O	N16	
DDRBA[1]	O	M14	
DDRCASN	O	L15	
DDRCKE	O	K13	
DDRCKN	O	J13	
DDRCKP	O	J15	
DDRCSN	O	P16	
DDRDATA[0]	I/O	C16	
DDRDATA[1]	I/O	D16	
DDRDATA[2]	I/O	D14	
DDRDATA[3]	I/O	D15	
DDRDATA[4]	I/O	E16	
DDRDATA[5]	I/O	E14	
DDRDATA[6]	I/O	E13	
DDRDATA[7]	I/O	F16	
DDRDATA[8]	I/O	F14	
DDRDATA[9]	I/O	F13	
DDRDATA[10]	I/O	G15	
DDRDATA[11]	I/O	G16	
DDRDATA[12]	I/O	H15	
DDRDATA[13]	I/O	H16	
DDRDATA[14]	I/O	H14	

Table 24 RC32435 Alphabetical Signal List (Part 2 of 7)

Signal Name	I/O Type	Location	Signal Category
DDRDATA[15]	I/O	H13	DDR Bus
DDRDM[0]	O	F15	
DDRDM[1]	O	G13	
DDRDQS[0]	I/O	J16	
DDRDQS[1]	I/O	G14	
DDRRASN	O	M13	
DDRVREF	I	J14	
DDRWEN	O	L14	
EJTAG_TMS	I	J4	JTAG / EJTAG
EXTBCV	I	D11	System
EXTCLK	O	C1	
GPIO[0]	I/O	H3	General Purpose Input/Output
GPIO[1]	I/O	H4	
GPIO[2]	I/O	J3	
GPIO[3]	I/O	J1	
GPIO[4]	I/O	A8	
GPIO[5]	I/O	B8	
GPIO[6]	I/O	C7	
GPIO[7]	I/O	A7	
GPIO[8]	I/O	L3	
GPIO[9]	I/O	M4	
GPIO[10]	I/O	P3	
GPIO[11]	I/O	M3	
GPIO[12]	I/O	M1	
GPIO[13]	I/O	T2	
JTAG_TCK	I	J2	JTAG / EJTAG
JTAG_TDI	I	A12	
JTAG_TDO	O	K1	
JTAG_TMS	I	C11	
JTAG_TRSTN	I	D12	

Table 24 RC32435 Alphabetical Signal List (Part 3 of 7)

Signal Name	I/O Type	Location	Signal Category
MADDR[0]	O	C15	Memory and Peripheral Bus
MADDR[1]	O	B16	
MADDR[2]	O	A16	
MADDR[3]	O	B15	
MADDR[4]	O	C14	
MADDR[5]	O	A15	
MADDR[6]	O	B14	
MADDR[7]	O	A14	
MADDR[8]	O	B13	
MADDR[9]	O	A13	
MADDR[10]	O	A5	
MADDR[11]	O	B5	
MADDR[12]	O	B10	
MADDR[13]	O	A10	
MADDR[14]	O	C10	
MADDR[15]	O	D10	
MADDR[16]	O	A9	
MADDR[17]	O	B9	
MADDR[18]	O	C9	
MADDR[19]	O	D9	
MADDR[20]	O	D8	
MADDR[21]	O	C8	
MDATA[0]	I/O	D7	
MDATA[1]	I/O	B6	
MDATA[2]	I/O	D6	
MDATA[3]	I/O	C5	
MDATA[4]	I/O	B7	
MDATA[5]	I/O	C6	
MDATA[6]	I/O	A6	
MDATA[7]	I/O	D5	

Table 24 RC32435 Alphabetical Signal List (Part 4 of 7)

Signal Name	I/O Type	Location	Signal Category
MIICL	I	D2	Ethernet Interface
MIICRS	I	D3	
MIIMDC	O	H2	
MIIMDIO	I/O	H1	
MIIRXCLK	I	F2	
MIIRXD[0]	I	D1	
MIIRXD[1]	I	D4	
MIIRXD[2]	I	E2	
MIIRXD[3]	I	E1	
MIIRXDV	I	G1	
MIIRXER	I	G3	
MIITXCLK	I	G4	
MIITXD[0]	O	E3	
MIITXD[1]	O	E4	
MIITXD[2]	O	F1	
MIITXD[3]	O	F3	
MIITXENP	O	F4	
MIITXER	O	G2	
OEN	O	A2	Memory and Peripheral Bus
PCIAD[0]	I/O	R14	PCI Bus Interface
PCIAD[1]	I/O	T14	
PCIAD[2]	I/O	T13	
PCIAD[3]	I/O	R13	
PCIAD[4]	I/O	P13	
PCIAD[5]	I/O	R12	
PCIAD[6]	I/O	T12	
PCIAD[7]	I/O	P12	
PCIAD[8]	I/O	R11	
PCIAD[9]	I/O	T11	
PCIAD[10]	I/O	P11	
PCIAD[11]	I/O	N11	
PCIAD[12]	I/O	R10	
PCIAD[13]	I/O	T10	
PCIAD[14]	I/O	P10	
PCIAD[15]	I/O	N10	
PCIAD[16]	I/O	T5	

Table 24 RC32435 Alphabetical Signal List (Part 5 of 7)

Signal Name	I/O Type	Location	Signal Category
PCISTOPN	I/O	P8	PCI Bus Interface
PCITRDYN	I/O	R8	
RSTN	I/O	B2	System
RWN	O	A1	Memory and Peripheral Bus
SCK	I/O	K2	Serial Peripheral Interface
SCL	I/O	L2	I ² C
SDA	I/O	L1	
SDI	I/O	L4	Serial Peripheral Interface
SDO	I/O	K4	
Vcc APLL		C12	Power
Vcc Core		E8, E9, F9, H5, H6, H12, J5, J11, J12, L8, M8, M9	
Vcc DDR		E11, E12, F12, G12, K12, L12, M11, M12	
Vcc I/O		E5, E6, E7, E10, F5, G5, K5, K6, L5, M5, M6, M7, M10	
Vcc PLL		B11	
Vss		F6, F7, F8, F10, F11, G6, G7, G8, G9, G10, G11, H7, H8, H9, H10, H11, J6, J7, J8, J9, J10, K7, K8, K9, K10, K11, L6, L7, L9, L10, L11	Ground
Vss APLL		B12	
Vss PLL		A11	
WAITACKN	I	D13	Memory and Peripheral Bus
WEN	O	C4	
Reserved		K3, L1, L2	

Table 24 RC32435 Alphabetical Signal List (Part 7 of 7)

